HL7601 Series is a high voltage (up to 40V) low power low dropout voltage regulator (LDO) manufactured in CMOS processes. It can deliver up to 1A of current while consuming only 12uA of quiescent current. It consists of a reference voltage generator, an error amplifier, a current foldback circuit, and a phase compensation circuit plus a driver transistor.

FEATURES

- Ultra-low Quiescent Current: 12uA
- Maximum Input Voltage: 40V
- Output Voltage Highly Accurate: ±2%
- Maximum Output Current: 1A
- Dropout Voltage: 10mV@I_{OUT}=10mA
- Temperature Stability: ±50ppm/℃
- Protections Circuits: Current Limiter, Short Circuit, Foldback, Thermal shutdown
- Output Capacitor: Low ESR Ceramic Capacitor Compatible

APPLICATIONS

- Smart wearer
- Long-life battery-powered devices
- Portable mobile devices, such as mobile phones, cameras, and so on
- Wireless communication equipment

Product Selections

Type	Output Voltage (note 1*)	Current Limit	Accuracy	Package (note 2*)	MARKING (note 3*)
HL7601A30	3.0V	1.8A	±2%	TO-252	7601A30
HL7601A33	3.3V	1.8A	±2%	TO-252	7601A33
HL7601A36	3.6V	1.8A	±2%	TO-252	7601A36
HL7601A40	4.0V	1.8A	±2%	TO-252	7601A40
HL7601A50	5.0V	1.8A	±2%	TO-252	7601A50
HL7601A12	12.0V	1.8A	±2%	TO-252	7601A12
HL7601B30	3.0V	1.8A	±2%	SOT-223	7601B30
HL7601B33	3.3V	1.8A	±2%	SOT-223	7601B33
HL7601B36	3.6V	1.8A	±2%	SOT-223	7601B36
HL7601B40	4.0V	1.8A	±2%	SOT-223	7601B40
HL7601B50	5.0V	1.8A	±2%	SOT-223	7601B50
HL7601B12	12.0V	1.8A	±2%	SOT-223	7601B12
HL7601C30	3.0V	1.8A	±2%	SOT-223	7601C30
HL7601C33	3.3V	1.8A	±2%	SOT-223	7601C33
HL7601C36	3.6V	1.8A	±2%	SOT-223	7601C36
HL7601C40	4.0V	1.8A	±2%	SOT-223	7601C40

HL7601C50	5.0V	1.8A	±2%	SOT-223	7601C50
HL7601C12	12.0V	1.8A	±2%	SOT-223	7601C12

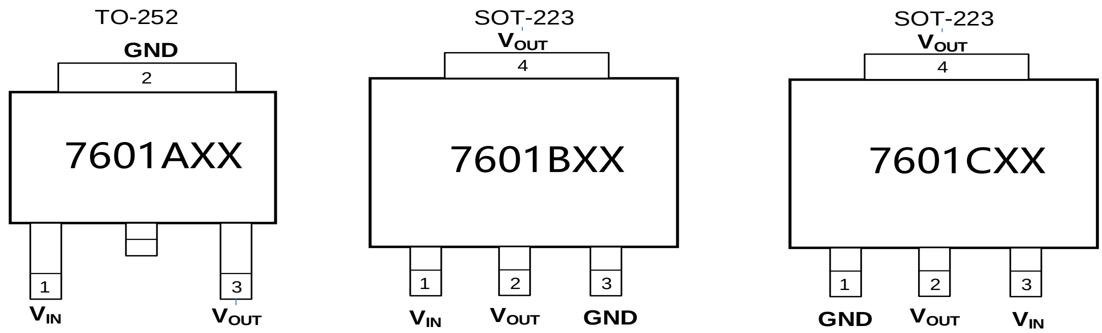
Notes:

1* Customer can request to customize the output voltage ranged from 1.2V to 15V if desired voltage is not found in the selections.

2* Customer can request customization of package choice.

3* Please pay attention to the MARKING of the product package type.

■ PIN CONFIGURATION (TOP VIEW)



■ Absolute Maximum Ratings (Unless otherwise indicated: T_a=25℃)

PARAMETER	SYMBOL	RATINGS	UNITS
Input Voltage	V_{IN}	-0.3 ~ 45	V
Output Voltage	V_{OUT}	Vss-0.3 ~ VIN+0.3V	
Power Dissipation	P_D	TO 252 1800 SOT 223 1500	mW
Operating Ambient Temperature	T_{opr}	-40 ~ +85	℃
Storage Temperature	T_{stg}	-40 ~ +125	
ESD Protection	ESD HBM	2000	V

Note: Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device.

■ ELECTRICAL CHARACTERISTICS

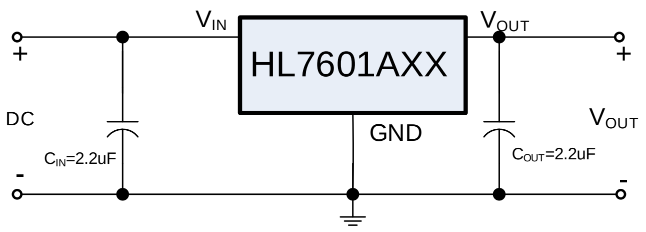
HL7601 Series (Unless otherwise indicated：T_a=25℃)

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Output Voltage[*1]	$V_{OUT(S)}$	V_{IN}= $V_{OUT(S)}$+2V，I_{OUT}=10mA	$V_{OUT(S)}$× 0.98	$V_{OUT(S)}$	$V_{OUT(S)}$× 1.02	V
Dropout Voltage[*2]	V_{DROP}	I_{OUT}=1mA		4	8	mV
		I_{OUT}=1A		1000	1500	
Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{IN} \bullet V_{OUT(s)}}$	$V_{OUT(S)}$+2V≤V_{IN}≤40V I_{OUT} =1mA		0.01	0.02	%/V
Load Regulation	ΔV_{OUT2}	V_{IN}=$V_{OUT(S)}$+2V 1mA≤I_{OUT}≤300mA, $V_{OUT(S)}$≤10V		20	80	mV
		V_{IN}=$V_{OUT(S)}$+2V 1mA≤I_{OUT}≤300mA, $V_{OUT(S)}$>10V		85	150	
Temperature Stability	$\frac{\Delta V_{OUT}}{\Delta T_a \bullet V_{OUT(s)}}$	V_{IN} = $V_{OUT(S)}$+2V，I_{OUT}=10mA -40℃≤T_a≤85℃		±50		ppm/℃
GND Current	I_{GND}	no load, $V_{OUT(S)}$≤10V		10	30	uA
		no load, $V_{OUT(S)}$>10V		12	30	
		I_{OUT}=100mA		460		
Input Voltage	V_{IN}	---	2.2		40	V
Maximum Output Current	I_{OUTMAX}		1			A
Current Limit[*3]	I_{LIM}	V_{IN}= $V_{OUT(S)}$+2V, V_{OUT} = 0.95 ×$V_{OUT(S)}$		1.8		
Short Circuit Current	I_{SHORT}	V_{IN}=$V_{OUT(S)}$+2V V_{OUT}=0V, $V_{OUT(S)}$≤10V		50		mA
		V_{IN}=$V_{OUT(S)}$+2V V_{OUT}=0V, $V_{OUT(S)}$>10V		75		
Power Supply Rejection Ratio	PSRR	f=10Hz, $V_{OUT(S)}$=3.6V		84		dB
		f=100Hz, $V_{OUT(S)}$=3.6V		80		
		f=1kHz, $V_{OUT(S)}$=3.6V		58		
Over Temperature Protection	OTP	I_{OUT}=1mA		180		℃

Notes:

1. $V_{OUT(S)}$: Output voltage when V_{IN}=V_{OUT}+2V, I_{OUT}=1 mA.
2. V_{DROP}=V_{IN1} -（$V_{OUT(S)}$× 0.98）where V_{IN1} is the input voltage when V_{OUT} = $V_{OUT(S)}$× 0.98.
3. I_{LIM}: Output current when V_{IN}=$V_{OUT(S)}$+2V and V_{OUT} = 0.95*$V_{OUT(S)}$.

■ TYPICAL APPLICATIONS



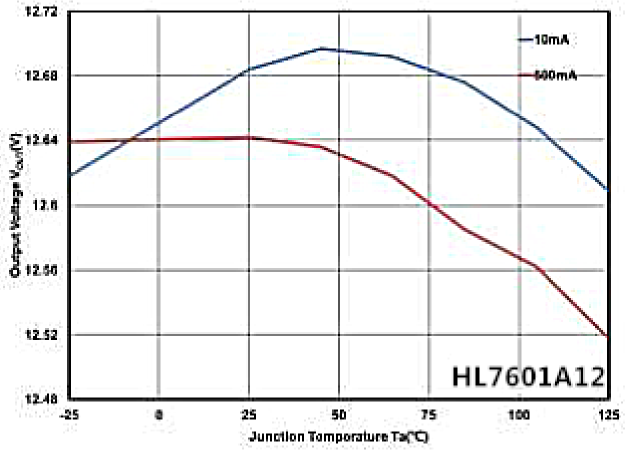
■ Notes on Use

Input Capacitor (C_{IN}): 2.2μF above

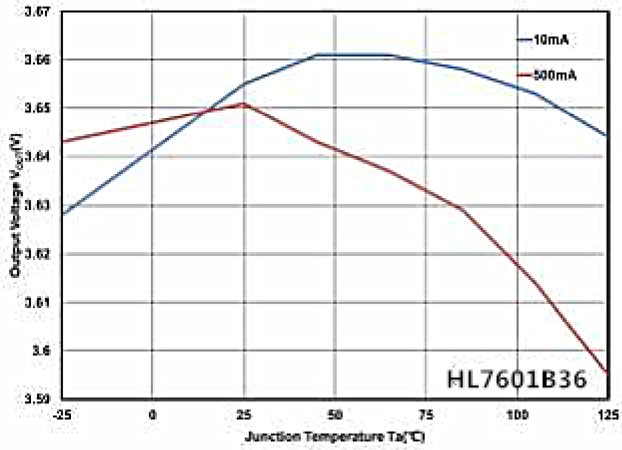
Output Capacitor (C_{OUT}): 2.2μF above

■ TYPICAL PERFORMANCE CHARACTERISTICS(CONTINUTED)

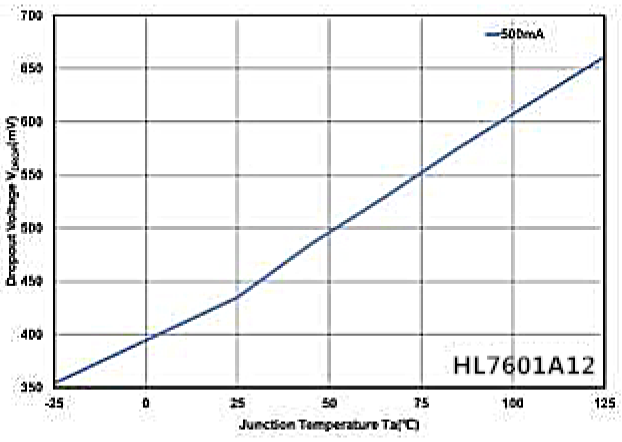
Test Conditions: $V_{IN}=V_{OUT}+2.0V$, $C_{IN}=2.2\mu F$, $C_{OUT}=2.2\mu F$, unless otherwise indicated.



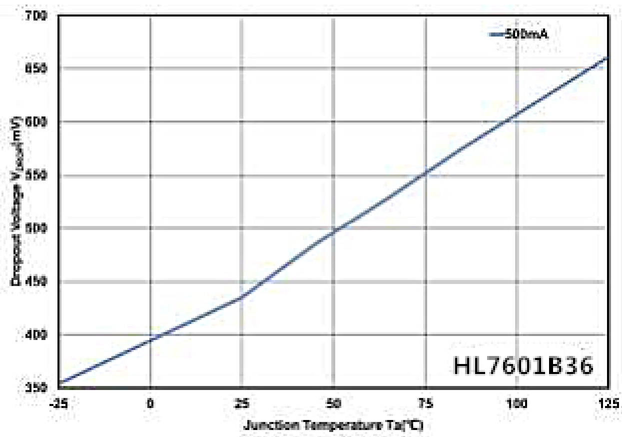
V_{OUT} vs Temperature at V_{OUT}=12V



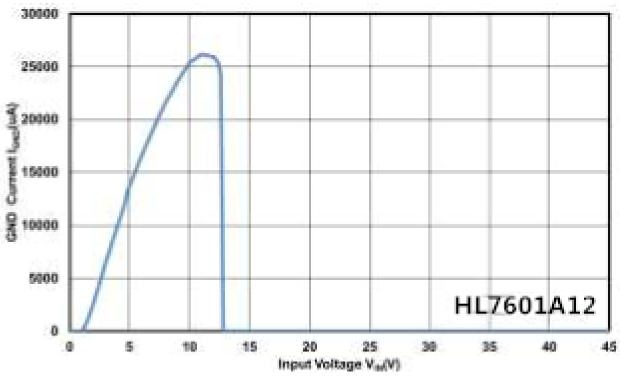
V_{OUT} vs Temperature at V_{OUT}=3.6V



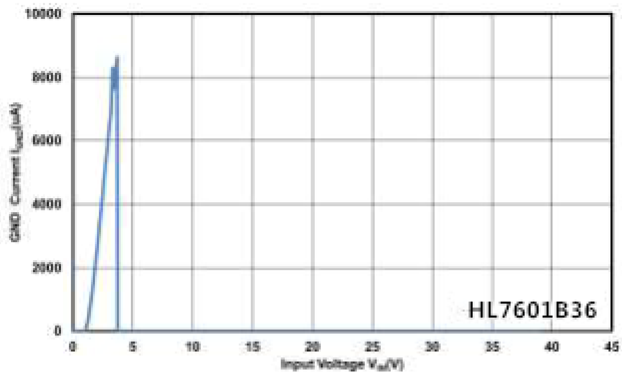
V_{DROP} vs Temperature at V_{OUT}=12V



V_{DROP} vs Temperature at V_{OUT}=3.6V



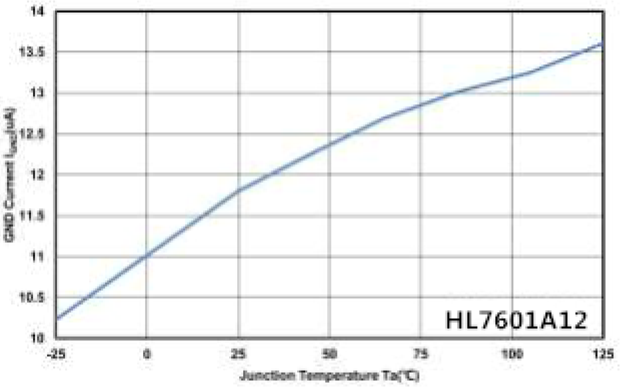
GND Current vs Input Voltage at V_{OUT}=12V



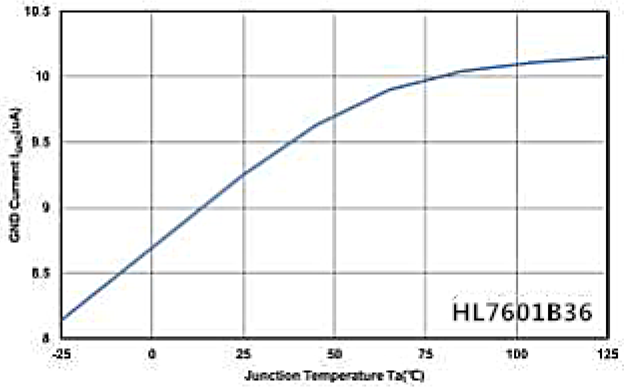
GND Current vs Input Voltage at V_{OUT}=3.6V

■ TYPICAL PERFORMANCE CHARACTERISTICS(CONTINUTED)

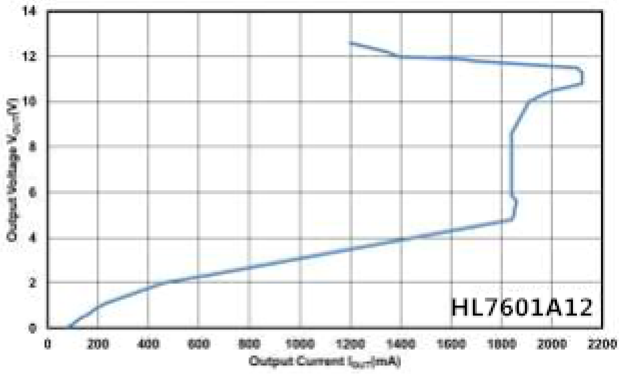
Test Conditions: $V_{IN}=V_{OUT}+2.0V$, $C_{IN}=2.2\mu F$, $C_{OUT}=2.2\mu F$, unless otherwise indicated.



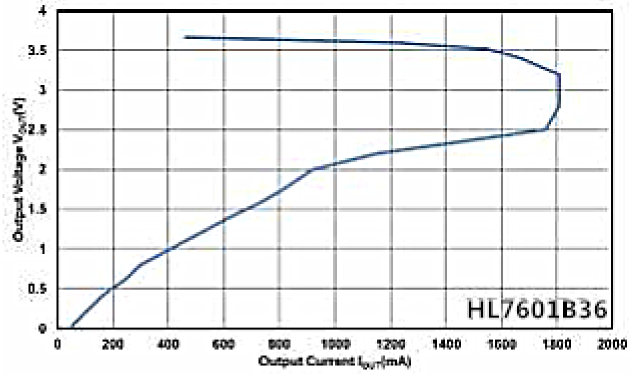
GND Current vs Temperature at V_{OUT}=12V



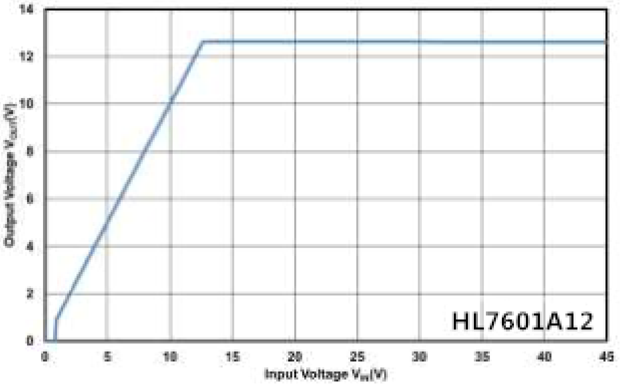
GND Current vs Temperature at V_{OUT}=3.6V



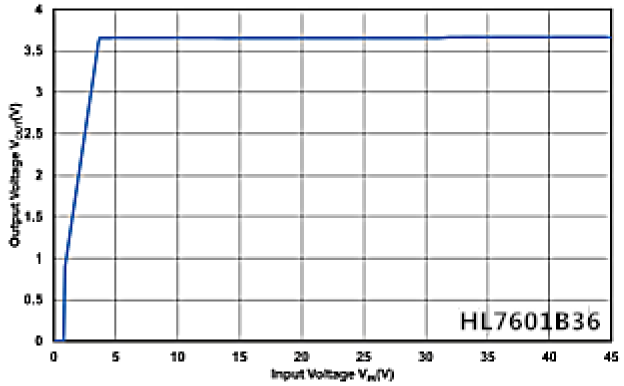
Output Current Fold-back at V_{OUT}=12V



Output Current Fold-back at V_{OUT}=3.6V



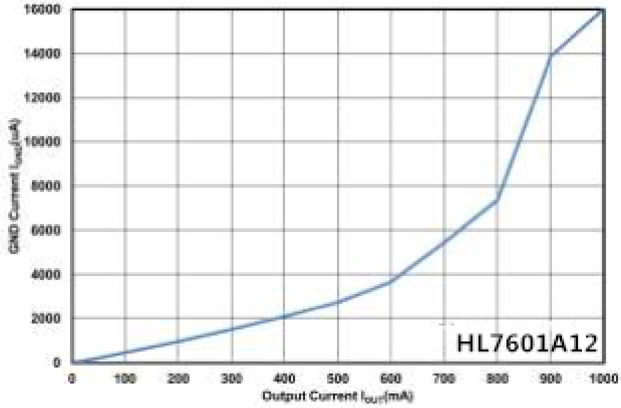
Output Voltage vs Input Voltage at V_{OUT}=12V



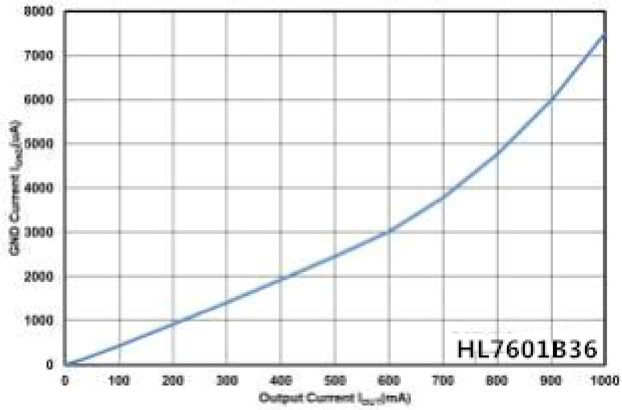
Output Voltage vs Input Voltage at V_{OUT}=3.6V

■ TYPICAL PERFORMANCE CHARACTERISTICS(CONTINUTED)

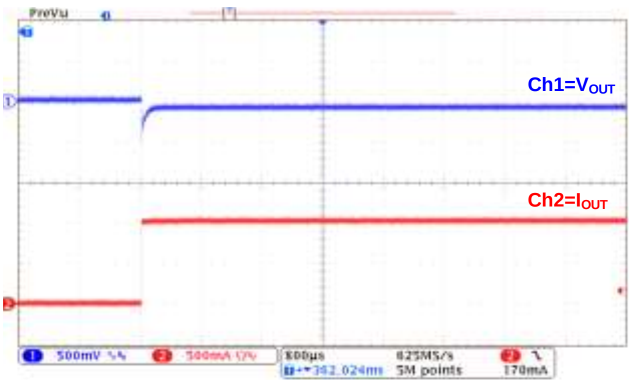
Test Conditions: $V_{IN}=V_{OUT}+2.0V$, $C_{IN}=2.2\mu F$, $C_{OUT}=2.2\mu F$, unless otherwise indicated.



GND Current vs Output Current at V_{OUT}=12V

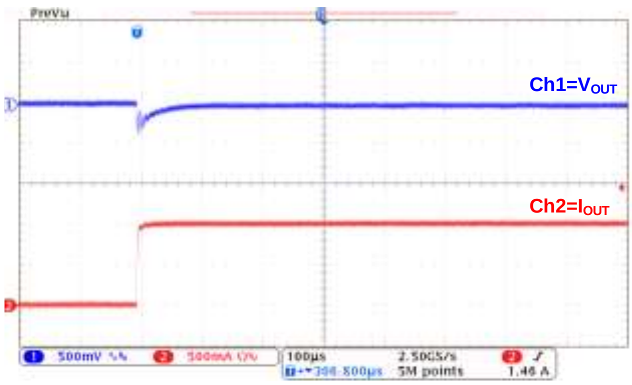


GND Current vs Output Current at V_{OUT}=3.6V



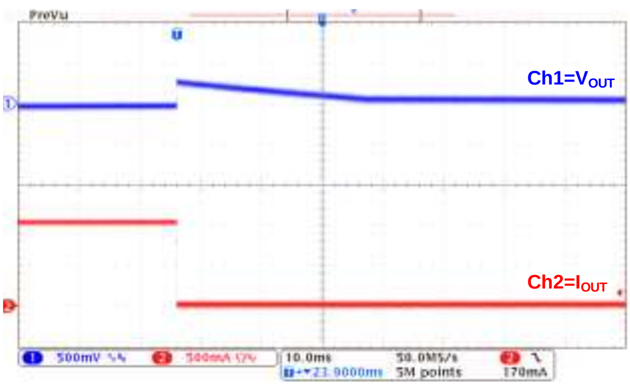
Load Transient at V_{OUT}=12V

7601A12(I_{OUT}=0mA~1A)



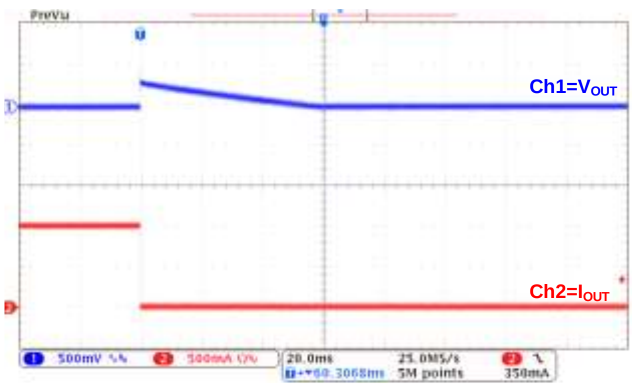
Load Transient at V_{OUT}=3.6V

7601B36(I_{OUT}=0mA~1A)



Load Transient at V_{OUT}=12V

7601A12(I_{OUT}=1A~0mA)

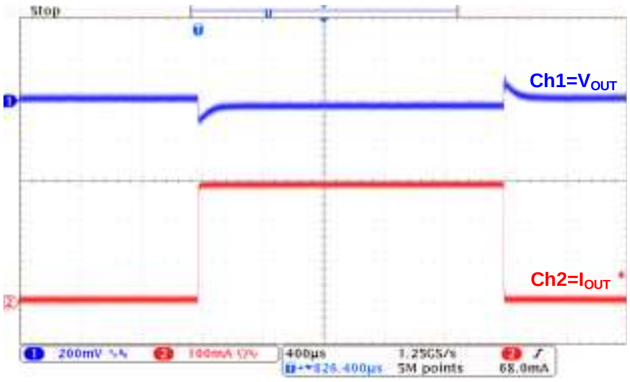


Load Transient at V_{OUT}=3.6V

7601B36(I_{OUT}=1A~0mA)

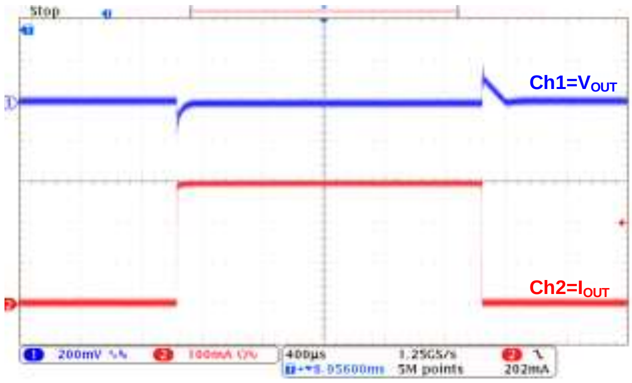
■ TYPICAL PERFORMANCE CHARACTERISTICS(CONTINUTED)

Test Conditions: $V_{IN}=V_{OUT}+2.0V$, $C_{IN}=2.2\mu F$, $C_{OUT}=2.2\mu F$, unless otherwise indicated.



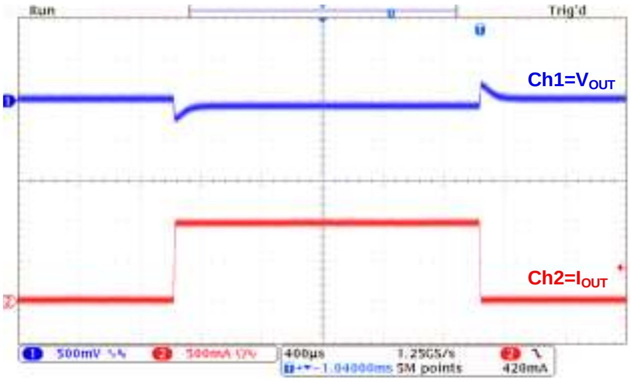
Load Transient at $V_{OUT}=12V$

7601A12(I_{OUT}=1mA~300mA~1mA)



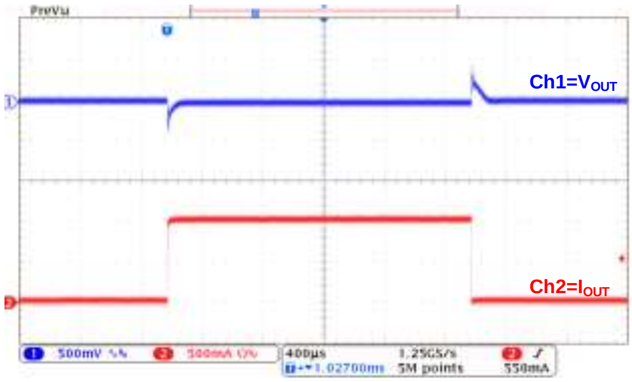
Load Transient at $V_{OUT}=3.6V$

7601B36(I_{OUT}=1mA~300mA~1mA)



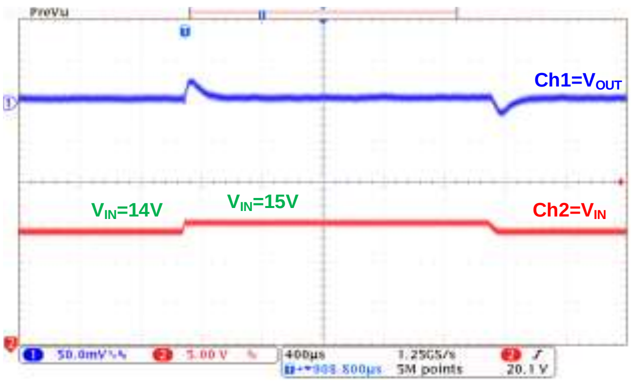
Load Transient at $V_{OUT}=12V$

7601A12(I_{OUT}=1mA~1A~1mA)



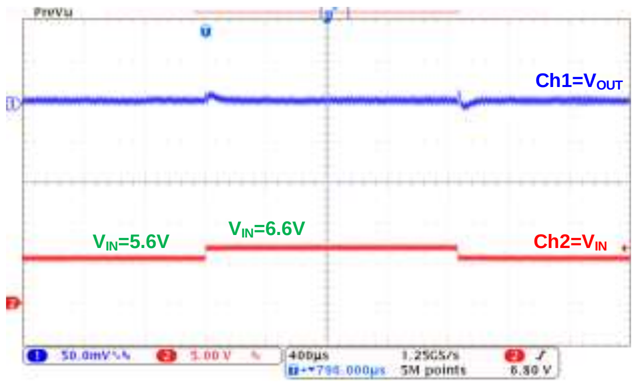
Load Transient at $V_{OUT}=3.6V$

7601B36(I_{OUT}=1mA~1A~1mA)



Line Transient at $V_{OUT}=12V$

7601A12(I_{OUT}=1mA)

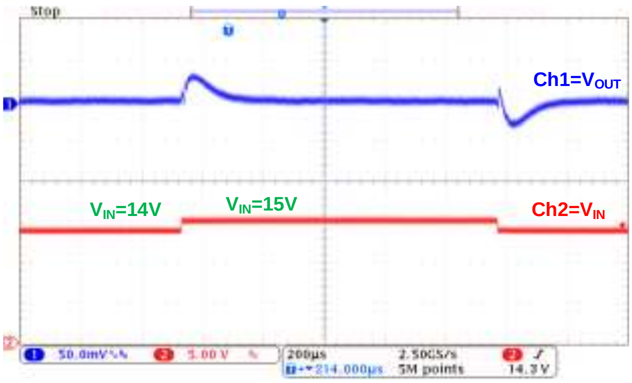


Line Transient at $V_{OUT}=3.6V$

7601B36(I_{OUT}=1mA)

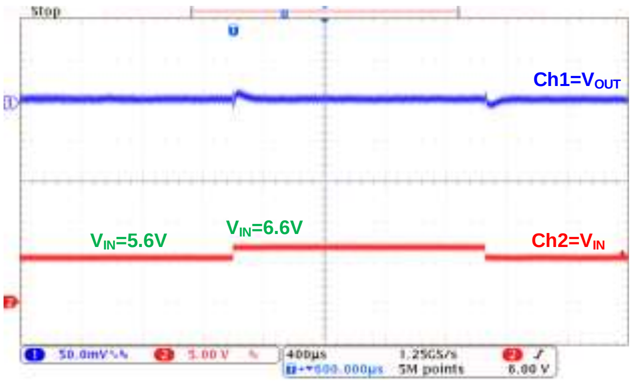
■ TYPICAL PERFORMANCE CHARACTERISTICS(CONTINUTED)

Test Conditions: $V_{IN}=V_{OUT}+2.0V$, $C_{IN}=2.2\mu F$, $C_{OUT}=2.2\mu F$, unless otherwise indicated.



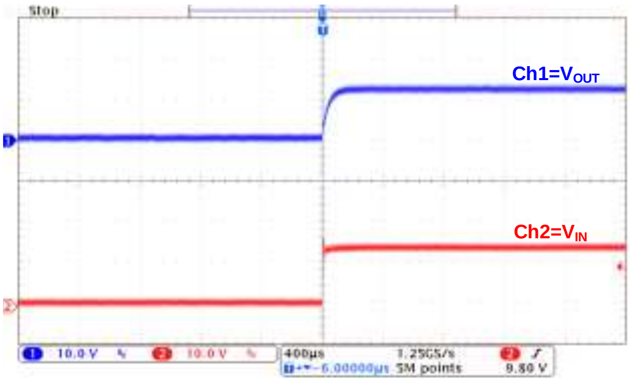
Line Transient at $V_{OUT}=12V$

7601A12($I_{OUT}=10mA$)



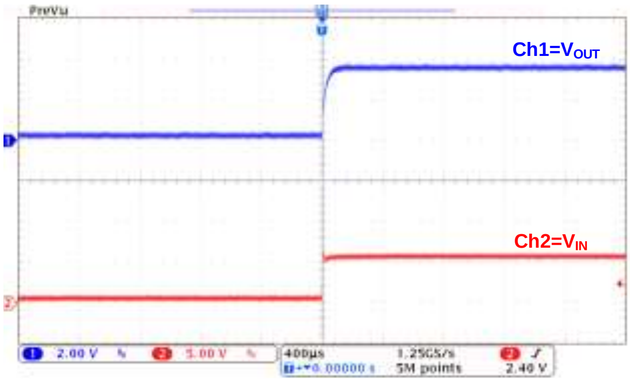
Line Transient at $V_{OUT}=3.6V$

7601B36($I_{OUT}=10mA$)



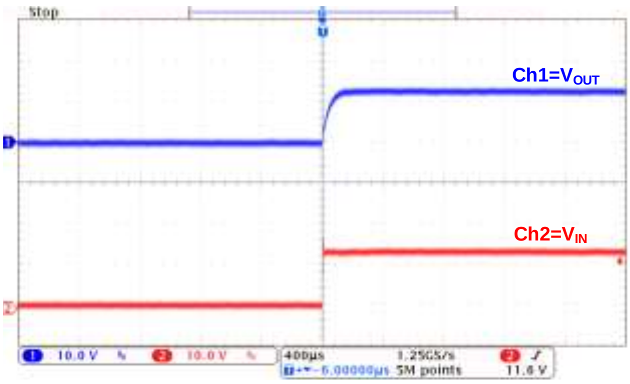
Power-Up at $V_{OUT}=12V$

7601A12($I_{OUT}=0mA$)



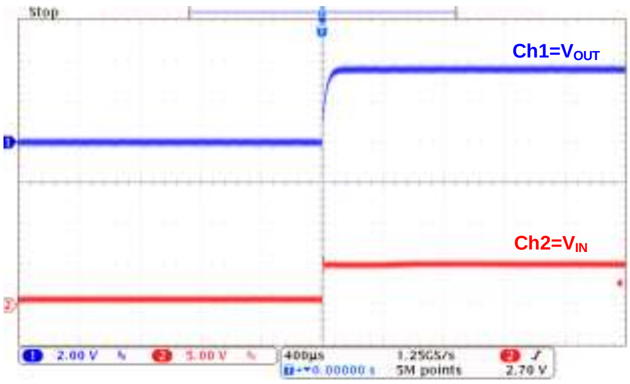
Power-Up at $V_{OUT}=3.6V$

7601B36($I_{OUT}=0mA$)



Power-Up at $V_{OUT}=12V$

7601A12($I_{OUT}=1A$)

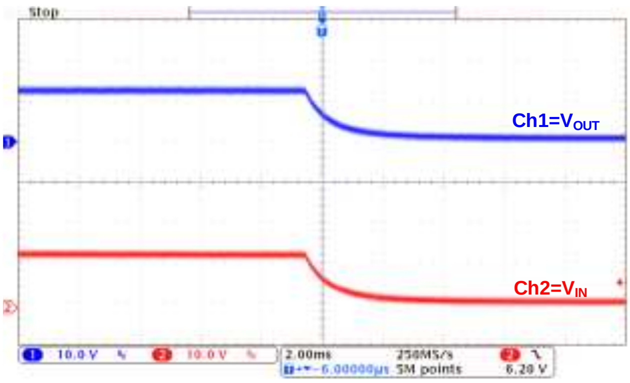


Power-Up at $V_{OUT}=3.6V$

7601B36($I_{OUT}=1A$)

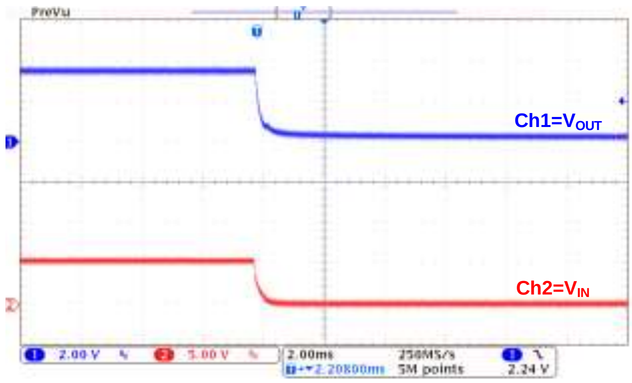
■ TYPICAL PERFORMANCE CHARACTERISTICS(CONTINUTED)

Test Conditions: $V_{IN}=V_{OUT}+2.0V$, $C_{IN}=2.2\mu F$, $C_{OUT}=2.2\mu F$, unless otherwise indicated.



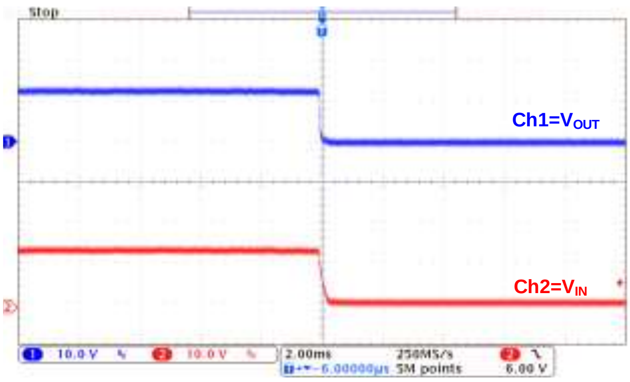
Power-Down at V_{OUT}=12V

7601A12(I_{OUT}=0mA)



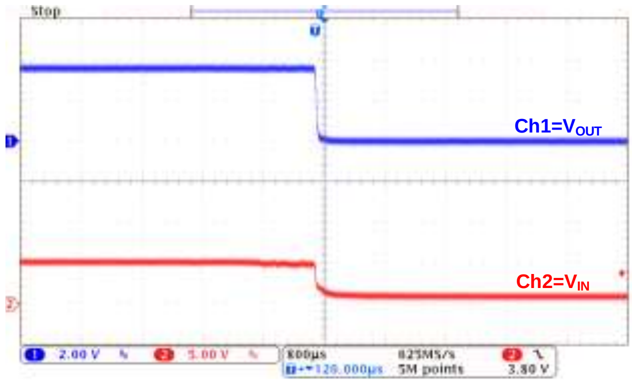
Power- Down at V_{OUT}=3.6V

7601B36(I_{OUT}=0mA)



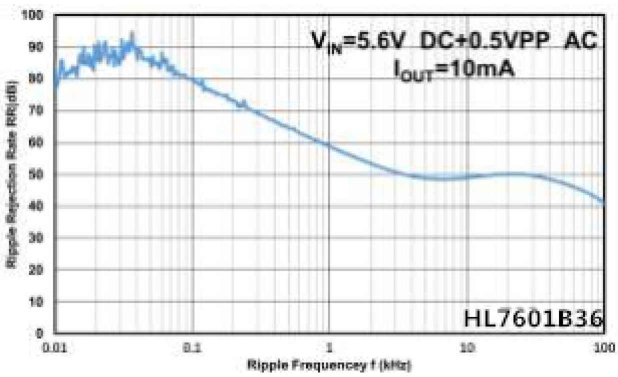
Power- Down at V_{OUT}=12V

7601A12(I_{OUT}=1A)



Power- Down at V_{OUT}=3.6V

7601B36(I_{OUT}=1A)

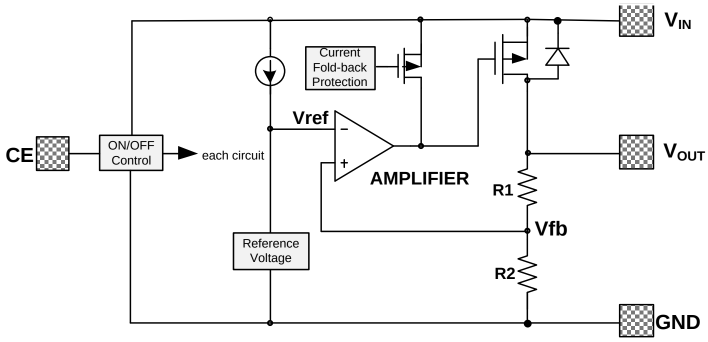


Power Supply Rejection Ratio at V_{OUT}=3.6V

■ OPERATIONAL EXPLANATION

1. Output voltage control

The voltage divided by resistors R1 and R2 is compared with the internal reference voltage by the error amplifier. The amplifier output then drives the P-channel MOSFET connected to the V_{OUT} pin. The output voltage at the V_{OUT} pin is regulated by this negative feedback system. The current limit circuit and short protect circuit operate in relation to output current level. Further, the IC's internal circuitry can be in operation or shutdown modes controlled by the CE pin's signal.



2. Pass transistor

The pass transistor with low turn-on resistance used in HL83XX is a P-channel MOSFET. If the potential on V_{OUT} pin is higher than VIN, it is possible that IC will be destroyed due to reverse current which is caused by parasitic diodes between V_{IN} and V_{OUT}. Therefore, the V_{OUT} pin potential exceeds V_{IN}+0.3V is not allowed.

3. Current foldback, short circuit protection and over temperature protection

The HL83XX series includes a combination of a fixed current limiter circuit and a foldback circuit, which aid the operations of the current limiter and circuit protection. When the load current reaches the current limit level, the fixed current limiter circuit operates and output voltage drops. As a result of this drop in output voltage, the foldback circuit operates, output voltage drops further and output current decreases. The short circuit current is about 65mA (typical value). This design can prevent the chip be damaged due to over temperature, moreover, the heat dissipation is limited by the package type.

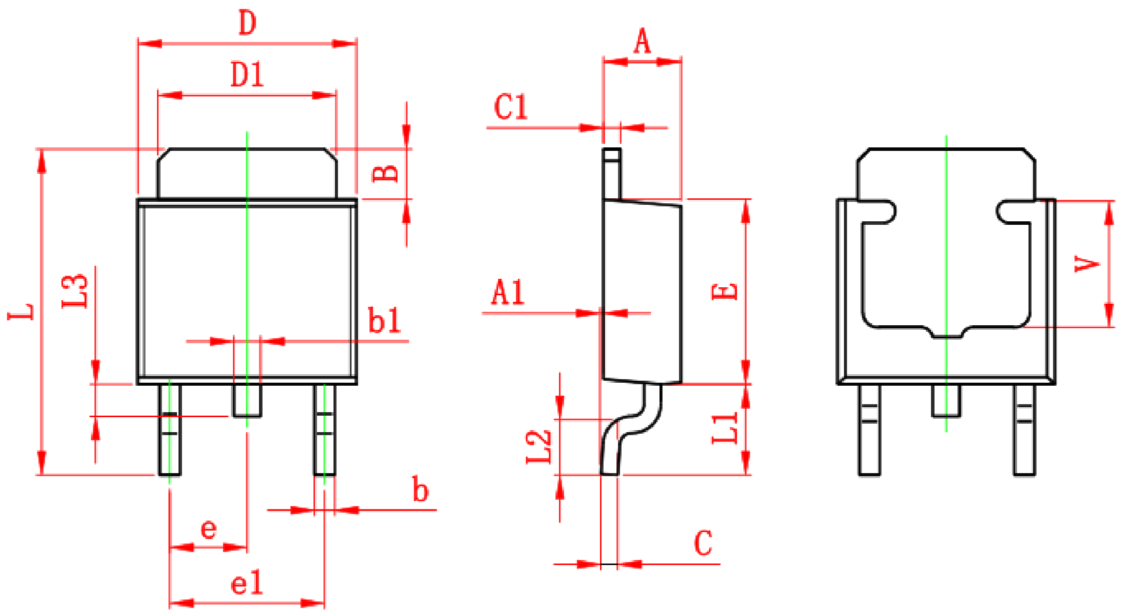
Special attention should be paid to that the product of the dropout voltage on the chip and the output current must be smaller than the heat dissipation. If power consumption on the chip is more than the heat dissipation, OTP will protect the chip from damaging due to over temperature.

■ Notes:

1. The input and output capacitors should be placed as close as possible to the IC.
2. If the impedance of the power supply is high, which is caused by forgetting installing input capacitor or installing too small value capacitor, the oscillation may occur.
3. Pay attention to the operation conditions of input and output voltage and load current, such that the power consumption in the IC should not exceed the allowable power consumption of the package even though the chip has short circuit protection.
4. IC has a built-in anti-static protection (ESD) circuit, but please do not add excessive stress to the IC.

■ PACKAGING INFORMATION

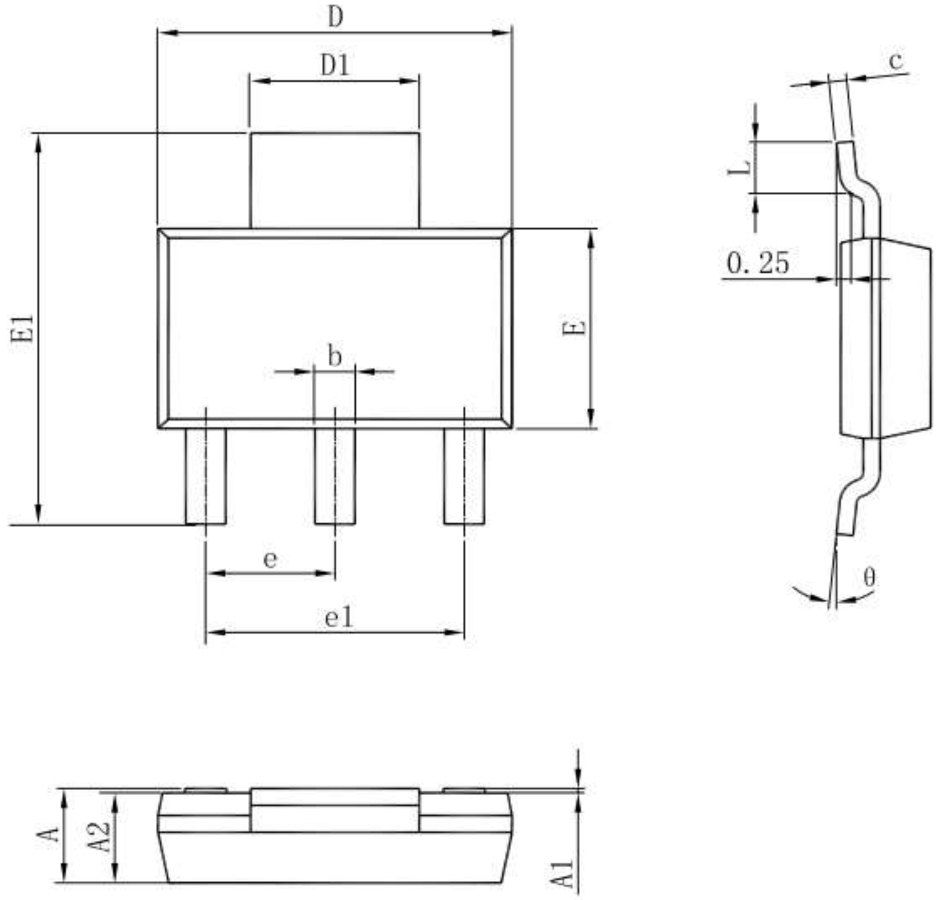
TO-252-2L PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
B	1.350	1.650	0.053	0.065
b	0.500	0.700	0.020	0.028
b1	0.700	0.900	0.028	0.035
c	0.430	0.580	0.017	0.023
c1	0.430	0.580	0.017	0.023
D	6.350	6.650	0.250	0.262
D1	5.200	5.400	0.205	0.213
E	5.400	5.700	0.213	0.224
e	2.300 TYP.		0.091 TYP.	
e1	4.500	4.700	0.177	0.185
L	9.500	9.900	0.374	0.390
L1	2.550	2.900	0.100	0.114
L2	1.400	1.780	0.055	0.070
L3	0.600	0.900	0.024	0.035
V	3.800 REF.		0.150 REF.	

■ PACKAGING INFORMATION(Continued)

SOT-223 PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.520	1.800	0.060	0.071
A1	0.000	0.100	0.000	0.004
A2	1.500	1.700	0.059	0.067
b	0.660	0.820	0.026	0.032
c	0.250	0.350	0.010	0.014
D	6.200	6.400	0.244	0.252
D1	2.900	3.100	0.114	0.122
E	3.300	3.700	0.130	0.146
E1	6.830	7.070	0.269	0.278
e	2.300(BSC)		0.091(BSC)	
e1	4.500	4.700	0.177	0.185
L	0.900	1.150	0.035	0.045
θ	0°	10°	0°	10°